



Peak pulse voltage ( $T_j=25$ ; non-repetitive, off-state; FIG.8)	$V_{pp}$	3	kV
--	----------	---	----

ELECTRICAL CHARACTERISTICS (unless otherwise specified)

Symbol	Test Condition	Quadrant	Value		Unit
$I_{GT}$	$V_D=12V R_L=33$	- -	MAX.	20	mA
$V_{GT}$		- -	MAX.	1	V
$V_{GD}$	$V_D=V_{DRM} T_j=150$ $R_L=3.3k$	- -	MIN.	0.2	V
$I_L$	$I_G=1.2I_{GT}$	-	MAX.	40	mA
				55	
$I_H$	$I_T=100mA$		MAX.	30	mA
dV/dt	$V_D=400V$ Gate Open $T_j=150$		MIN.	1000	V/s
(dI/dt) <sub>c</sub>	$V_D=150V$		MIN.	3	A/ms
	$I_G=10mA I_A=200mA I_R=20mA$		TYP.	3	s
	$t_{on}=25$			30	

CHARACTERISTICS

Parameter		Value(MAX.)	Unit
$I_G=11A t_p=380$ s	$T_j=25$	1.4	V
Threshold voltage	$T_j=150$	0.78	V
Dynamic resistance	$T_j=150$	55	P
$V_{DRM} V_R=V_{RRM}$	$T_j=25$	5	A
	$T_j=150$	1	mA

ORDERING INFORMATION

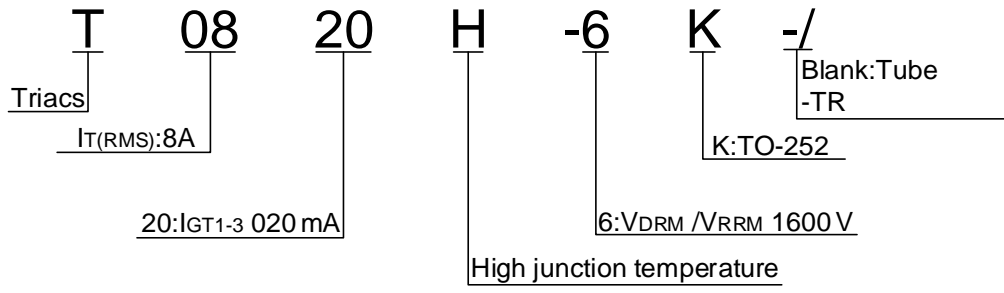


FIG.1: Maximum power dissipation versus RMS on-state current

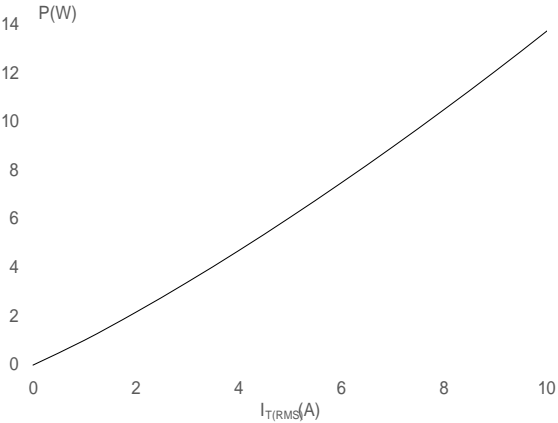


FIG.2: RMS on-state current versus case temperature

FIG.7: Relative variations of gate trigger current, holding current and latching current versus junction temperature

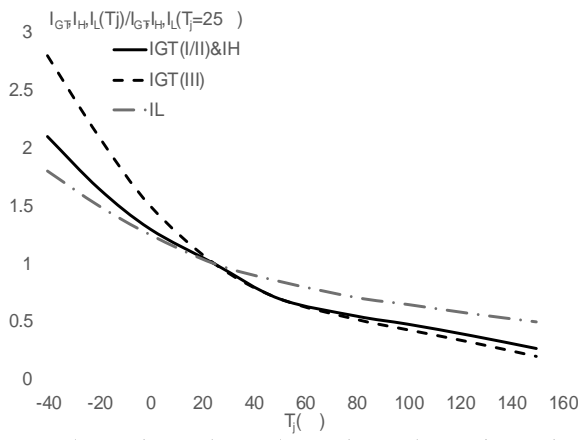


FIG.8 ÖTest circuit for inductive and resistive loads to IEC-61000-4-5 standards

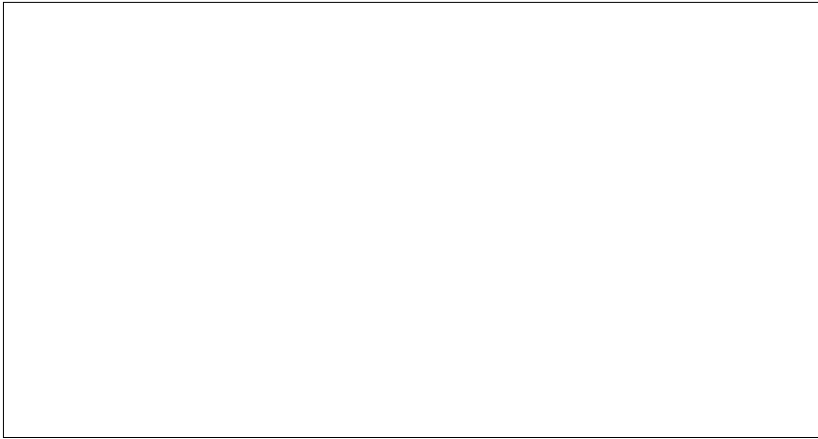


ORDERING INFORMATION

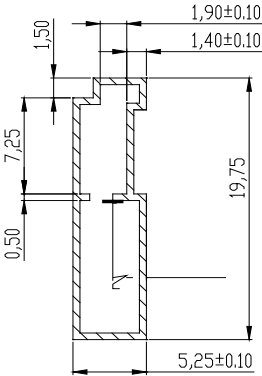
Order code	Voltage $V_{DRM}/V_{RRM}$ (V)	IGT(mA)	Package	Base qty. (pcs)	
------------	----------------------------------	---------	---------	--------------------	--

PACKAGE MECHANICAL DATA

Ref.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.15	0		0.006
B	0.66		0.86	0.026		0.034
C	0.40		0.60	0.016		0.024
D						
E	6.40					
G						
G1						
L						



DELIVERY MODE



Information furnished in this document is believed to be accurate and reliable. However, Jiangsu JieJie Microelectronics Co., Ltd. assumes no responsibility for the consequences of use without consideration for such information nor use beyond it. Information mentioned in this document is subject to change without notice, apart from that when an agreement is signed, Jiangsu JieJie complies with the agreement.

Products and information provided in this document have no infringement of patents.